

Appl. No. 10/773,592
Amdt. dated May 27, 2005
Reply to Office Action of

PATENT

REMARKS/ARGUMENTS

Claims 1-17 are pending. No new matter is introduced.

In the Office Action, Examiner indicated that this application is in condition for allowance except for certain formal matters. Specifically, Examiner objected to Figure 5 as failing to comply with 37 CFR 1.84(p)(5) because it contains reference characters '501' which is not mentioned in the specification. Applicant has corrected the specification to include the omitted characters. Applicant has noted certain informalities and amended such informalities in Figure 1A and 1B, as well as the specification. A replacement sheet and an annotated sheet for Figures 1A and 1B are filed with this amendment. Accordingly, all claims are now allowable.

CONCLUSION

In view of the foregoing, Applicant believes all claims now pending in this Application are in condition for allowance. The issuance of a formal Notice of Allowance at an early date is respectfully requested.

If the Examiner believes a telephone conference would expedite prosecution of this application, please telephone the undersigned at 650-326-2400.

Respectfully submitted,



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Amendments to the Drawings:

The attached sheet of drawings includes changes to Figure 1A and Figure 1B. This sheet, which includes Figure 1A and Figure 1B replaces the original sheet including Figure 1A and Figure 1B.

Attachment: Replacement Sheet
Annotated Sheet Showing Changes



Richard T. Ogawa, Reg. No. 37,692 (650) 326-2400
Attorney Docket No.: 021653-000400US Applicant: Pai, Chi Hong
Title: METHOD AND STRUCTURE TO FORM CAPACITOR IN COPPER
DAMASCENE PROCESS FOR INTEGRATED CIRCUIT DEVICES
Annotated Sheet Sheet 1 of 1

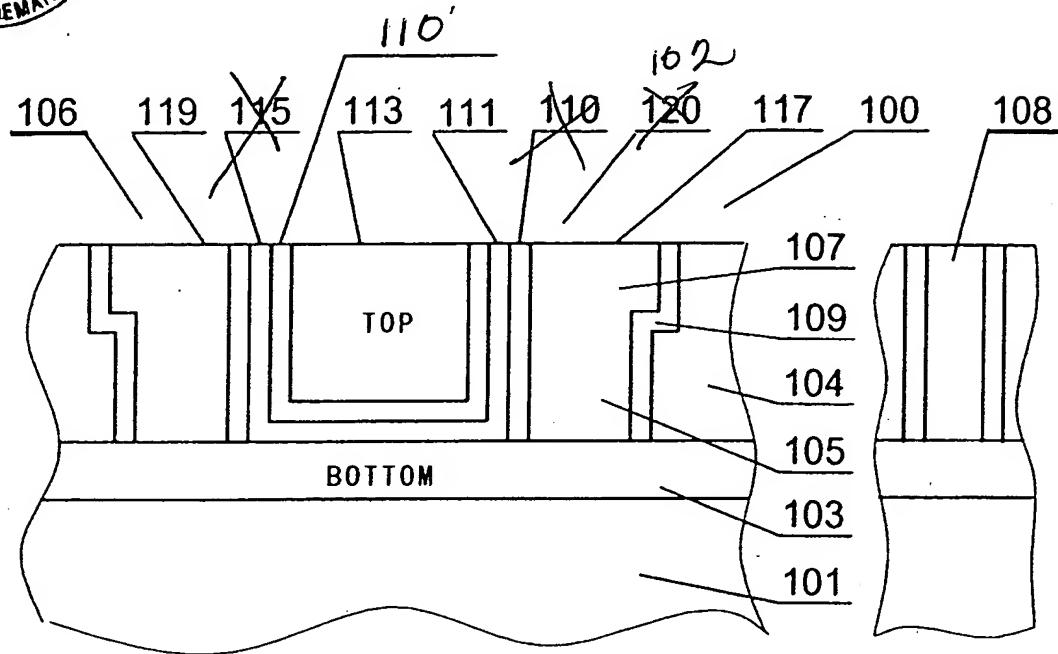


FIG. 1A

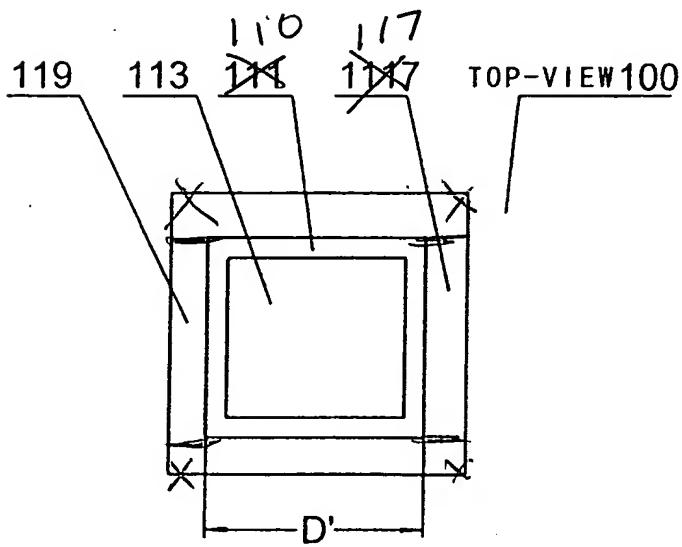


FIG. 1B